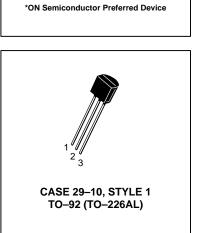
# **Amplifier Transistors** NPN Silicon

#### **MAXIMUM RATINGS**

Rating	Symbol	MPS918	MPS3563	Unit
Collector–Emitter Voltage	VCEO	15	12	Vdc
Collector-Base Voltage	VCBO	30	30	Vdc
Emitter-Base Voltage	VEBO	3.0	2.0	Vdc
Collector Current — Continuous	IC	50		mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	PD	350 2.8		mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	0.85 6.8		Watts mW/°C
Operating and Storage Junction Temperature Range	TJ, Tstg	–55 to +150		°C

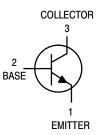


**MPS918\*** 

**MPS3563** 

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub> (1)	357	°C/W
Thermal Resistance, Junction to Case	$R_{\theta}JC$	147	°C/W



## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS		· · ·			
Collector–Emitter Breakdown Voltage(2) ( $I_C = 3.0 \text{ mAdc}, I_B = 0$ )	MPS918 MPS3563	V(BR)CEO	15 12		Vdc
Collector–Base Breakdown Voltage $(I_C = 1.0 \ \mu Adc, I_E = 0)$ $(I_C = 100 \ \mu Adc, I_E = 0)$	MPS918 MPS3563	V(BR)CBO	30 30	_	Vdc
Emitter–Base Breakdown Voltage (I <sub>E</sub> = 10 $\mu$ Adc, I <sub>C</sub> = 0)	MPS918 MPS3563	V(BR)EBO	3.0 2.0	_	Vdc
Collector Cutoff Current (V <sub>CB</sub> = 15 Vdc, I <sub>E</sub> = 0)	MPS918 MPS3563	ICBO	_	10 50	nAdc

1. R<sub>0JA</sub> is measured with the device soldered into a typical printed circuit board. 2. Pulse Test: Pulse Width  $\leq$  300 µs; Duty Cycle  $\leq$  1.0%.

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

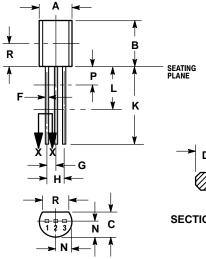
# MPS918 MPS3563

Characteristic	Symbol	Min	Max	Unit	
ON CHARACTERISTICS					
DC Current Gain <sup>(2)</sup> (I <sub>C</sub> = 3.0 mAdc, V <sub>CE</sub> = 1.0 Vdc) (I <sub>C</sub> = 8.0 mAdc, V <sub>CE</sub> = 10 Vdc)	MPS918 MPS3563	hFE	20 20	200	_
Collector–Emitter Saturation Voltage $(I_{C} = 10 \text{ mAdc}, I_{B} = 1.0 \text{ mAdc})$	MPS918	VCE(sat)	—	0.4	Vdc
Base–Emitter Saturation Voltage (I <sub>C</sub> = 10 mAdc, I <sub>B</sub> = 1.0 mAdc)	MPS918	VBE(sat)	—	1.0	Vdc
SMALL-SIGNAL CHARACTERISTICS					
$\begin{array}{l} \mbox{Current-Gain} &\mbox{Bandwidth Product}^{(2)} \\ (I_C = 4.0 \mbox{ mAdc}, \mbox{V}_{CE} = 10 \mbox{ Vdc}, \mbox{f} = 100 \mbox{ MHz}) \\ (I_C = 8.0 \mbox{ mAdc}, \mbox{V}_{CE} = 10 \mbox{ Vdc}, \mbox{f} = 100 \mbox{ MHz}) \end{array}$	MPS918 MPS3563	fΤ	600 600	 1500	MHz
Output Capacitance (V <sub>CB</sub> = 0 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz) (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz) (V <sub>CB</sub> = 10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)	MPS918 MPS918 MPS3563	C <sub>obo</sub>		3.0 1.7 1.7	pF
Input Capacitance (V <sub>EB</sub> = 0.5 Vdc, I <sub>C</sub> = 0, f = 1.0 MHz)	MPS918	C <sub>ibo</sub>	_	2.0	pF
Small–Signal Current Gain (I <sub>C</sub> = 8.0 mAdc, V <sub>CE</sub> = 10 Vdc, f = 1.0 kHz)	MPS3563	h <sub>fe</sub>	20	250	—
Noise Figure (I <sub>C</sub> = 1.0 mAdc, $V_{CE}$ = 6.0 Vdc, R <sub>S</sub> = 400 kΩ, f = 60 MHz)	MPS918	NF	—	6.0	dB
FUNCTIONAL TEST					
$ \begin{array}{l} \mbox{Common-Emitter Amplifier Power Gain} \\ (I_C = 6.0 \mbox{ mAdc}, \mbox{V}_{CB} = 12 \mbox{ Vdc}, \mbox{ f} = 200 \mbox{ MHz}) \\ (I_C = 8.0 \mbox{ mAdc}, \mbox{V}_{CE} = 10 \mbox{ Vdc}, \mbox{ f} = 200 \mbox{ MHz}) \\ (G_{fd} + G_{re} < -20 \mbox{ dB}) \end{array} $	MPS918 MPS3563	G <sub>pe</sub>	15 14	_	dB
Power Output (I <sub>C</sub> = 8.0 mAdc, V <sub>CB</sub> = 15 Vdc, f = 500 MHz)	MPS918	Pout	30	—	mW
Oscillator Collector Efficiency (I <sub>C</sub> = 8.0 mAdc, $V_{CB}$ = 15 Vdc, $P_{out}$ = 30 mW, f = 500 MHz)	MPS918	η	25	—	%

2. Pulse Test: Pulse Width  $\leq$  300 µs; Duty Cycle  $\leq$  1.0%.

# PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-10 ISSUE AL









- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED. 4. DIMENSIONS TAPPLIES BETWEEN P AND L. DIMENSIONS D AND J APPLY BETWEEN L AND K MIMIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.44	5.21
В	0.290	0.310	7.37	7.87
С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.457	0.533
F	0.016	0.019	0.407	0.482
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.018	0.024	0.46	0.61
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.135		3.43	

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